

COMPONENT HEATING OF POWER INDUCTORS IN SWITCHING REGULATORS USING IEC 62024

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WURTH ELEKTRONIK MORE THAN YOU EXPECT

HEATING SHOWN IN THE DATASHEET





Electrical Properties:

Properties		Test conditions	Value	Unit	Tol.
Inductance	L	100 kHz/ 1 V	1	μH	±30%
Rated Current	I _R	ΔT = 40 K	5.9	А	max.
Saturation Current	I _{SAT}	ΔL/L < 30 %	11.5	А	typ.
DC Resistance	R _{DC}	@ 20 °C	11	mΩ	±30%
Self Resonant Frequency	f _{res}		159	MHz	typ.
Operating Voltage	V	DC	120	V	max.

WHY DOES THE COMPONENT HEAT UP









WHAT IS RATED CURRENT

Typical Temperature Rise vs. Current Characteristics:



$$\mathsf{P}_{\mathsf{loss}} = \mathsf{I}_{\mathsf{DC}}^2 * \mathsf{R}_{\mathsf{DC}}$$

$$I_R = 7,3 \text{ A}$$
 | test condition $\Delta T = 40 \text{K}$



MARKET SITUATION OF RATED CURRENT DEFINITION



⁽³⁾ DC current (A) that will cause an approximate ΔT of 40 °C after one hour

⁽⁴⁾ DC current (A) that will cause an approximate ΔT of 100 °C after one hour

Irms is the DC current which cause the surface temperature of the part increase less than 45°C.

Rated Current (max)	1.4 A (⊿L=30%, ⊿T=25℃),
	1.8 A (⊿L=30%, ⊿T=40°C)

DC current (A) that will cause an approximate ΔT of 40 °C

Temperature Rise40 °C at rated I_{rms}¹ Rated Current

Rated Current : Value defined when DC current flows and Rated Current (Based on Inductance change)

HOW TO INCREASE THE RATED CURRENT

$\mathbf{P}_{\mathsf{loss}} = \mathbf{I}_{\mathsf{DC}}^{2} * \mathbf{R}_{\mathsf{DC}}$

 $R = \rho * \frac{\iota}{A}$







OTHER OPTIONS NEXT TO THE RDC





IMPACT OF THE PCB ON THE HEATING





RATED CURRENT DEFINITION AND SPECIFICATION

%3 Temperature rise current: The actual value of DC current when temperature of coil rise is Δ T=40[°]C (Ta=25[°]C) Board conditions: FR4, Copper=70µm,four-layer PWB, t=1.6mm.

The part temperature (ambient + temp. rise) should not exceed 155 °C under worst case operating conditions. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application

Rated current Itemp.tvp	Current that will cause a $\Delta 40^{\circ}$ K self-heating at room
	temperature

Irms Testing

Irms testing was performed on 0.75 inch wide $\times 0.25$ inch thick copper traces in still air.

Temperature rise is highly dependent on many factors including pcb land pattern, trace size, and proximity to other components. Therefore temperature rise should be verified in application conditions. ¹Circuit design, component, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.



WEAK POINTS OF CURRENT SPECIFICATION

- Test setup with insufficient description
 - Many influences which can corrupt the final result
- Specified value is difficult to put in relation to the real application
 - Is a first indicator, but hard to assume if it useful for end application
 - Choosing the best component out of many is difficult because the numbers aren't comparable
- How to improve?



IEC 62024-2:2020

Classification Performance Rated Current

Tabelle 2 – Leiterbahnbreite und -dicke

Bemessungs- stromklasse	Leiter- bahnbreite <i>W</i>	Leiter- bahndicke <i>t</i>	Beispielanwendung			
	mm	μm				
I _{Klasse A}	(1,0 bis 22,0) ± (0,2 bis 0,5)	35 ± 10	Verbraucheranwendung (Anwendungen mit einseitigen Leiterplatten)			
I _{Klasse B}	40 ± 0,2	35 ± 10	Verbraucheranwendung (Anwendungen mit doppelseitigen Leiterplatten)			
I _{Klasse C}	40 ± 0,2	105 ± 10	Verbraucheranwendung (Anwendungen mit mehrlagigen Leiterplatten)			
I _{Klasse D}	40 ± 0,2	1 000 ± 50	Anwendungen von Automobil- oder Energie- versorgungsunternehmen			
ANMERKUNG 1	I _{Klasse A} : siehe Bild 2a).				
ANMERKUNG 2	I _{Klasse B} , I _{Klasse C} , I _{Klasse D} : siehe Bild 2b).					



Trace thickness = 1 mm. FR4 thickness = 1 mm.



IEC 62024-2:2020

WE Definition of Performance Rated current

- Class B: Product Series with standard requirement profile
- Class C: Product with are used in high packing density application
- Class D: Products with current capability higher then 30A



EXAMPLE CLASS B

74477001

WE-PD







Electrical Properties:

Properties		Test conditions	Value	Unit	Tol.
Inductance	L	100 kHz/ 250 mV	1.2	μH	±30%
Rated Current	I _{R,40K}	$\Delta T = 40 \text{ K}$	13.5	А	max.
Performance Rated Current ¹⁾	I _{RP,40K}	$\Delta T = 40 \text{ K}$	16.2	А	max.
Saturation Current @ 10%	I _{SAT, 10%}	IΔL/LI < 10 %	21	А	typ.
Saturation Current @ 30%	I _{SAT,30%}	IΔL/LI < 30 %	27	Α	typ.
DC Resistance	R _{DC}	@ 20 °C	4.6	mΩ	typ.
DC Resistance	R _{DC}	@ 20 °C	7	mΩ	max.
Self Resonant Frequency	f _{res}		45	MHz	typ.
Operating Voltage	V	DC	120	۷	max.

¹⁾ refer to IEC 62024-2-2020

Test conditions of Performance Rated Current: refer to IEC 62024-2-2020, Class B PCB Copper Width: 40 mm; PCB Copper Thickness: 35 µm)

EXAMPLE CLASS C

74437377010

WE-LHMI



Electrical Properties:

Properties		Test conditions	Value	Unit	Tol.
Inductance	L	100 kHz/ 10 mA	1	μH	±20%
Rated Current	I _{R,40K}	$\Delta T = 40 \text{ K}$	15	А	max.
Performance Rated Current ¹⁾	I _{RP,40K}	$\Delta T = 40 \text{ K}$	23.5	А	max.
Saturation Current @ 10%	I _{SAT,10%}	ΙΔL/LI < 10 %	15.4	А	typ.
Saturation Current @ 30%	I _{SAT,30%}	ΙΔL/LI < 30 %	38	А	typ.
DC Resistance	R _{DC}	@ 20 °C	2.7	mΩ	typ.
DC Resistance	R _{DC}	@ 20 °C	3.5	mΩ	max.
Self Resonant Frequency	f _{res}		41	MHz	typ.

¹⁾ refer to IEC 62024-2-2020

Test conditions of Rated Current: refer to IEC 62024-2-2020, Class C PCB Copper Width: 40 mm; PCB Copper Thickness: 105 µm)



EXAMPLE CLASS D

744303015

WE-HCM



Electrical Properties:

Properties		Test conditions	Value	Unit	Tol.
Inductance	L	100 kHz/ 10 mA	155	nH	±20%
Rated Inductance	L _R	100 kHz/ 10 mA/ 31.0 A	150	nH	typ.
Rated Current	I _{R,40K}	$\Delta T = 40 \text{ K}$	31	Α	max.
Performance Rated Current ¹⁾	I _{RP,40K}	ΔT = 40 K	<mark>6</mark> 3.9	А	max.
Saturation Current @ 10%	I _{SAT,10%}	ΙΔL/LI < 10 %	44.5	А	typ.
Saturation Current @ 30%	I _{SAT,30%}	ΙΔL/LI < 30 %	51.5	А	typ.
DC Resistance	R _{DC}	@ 20 °C	0.325	mΩ	±7%
Self Resonant Frequency	f _{res}		110	MHz	typ.

¹⁾ refer to IEC 62024-2-2020

Test conditions of Performance Rated Current: refer to IEC 62024-2 Class D PCB Copper Width: 40 mm; PCB Copper Thickness: 1000 µm)



PERFORMANCE RATED CURRENT

- Rated Current (I_R) measured on WE legacy PCB boards
- Performance Rated Current (I_{RP}) measured on Class B, Class C or Class D PCBs

Further information can be found in application note ANP096



Electrical Properties:

Properties		Test conditions	Value	Unit	Tol.
Inductance		100 kHz/ 10 mA	22	uН	+20%
Rated Current	I _R	ΔT = 40 K	16	Α	max.
Performance Rated Current ¹⁾	I _{RP,40K}	ΔT = 40 K	32.05	Α	max.
Saturation current @ 10%	SAT, 10%	I∆L/LI < 10 %	15.00	А	typ.
Saturation Current @ 30%	I _{SAT,30%}	IΔL/LI < 30 %	32.1	Α	typ.
DC Resistance	R _{DC}	@ 20 °C	2.2	mΩ	±10%
Solf Reconant Frequency	f _{res}		28	MHz	typ.
¹⁾ refer to IEC 62024-2-2020					
Certification:					
RoHS Approval	Compliant [2011/65/EU&2015/863]				
REACh Approval	Conform or declared [(EC)1907/2006]				
Halogen Free	Conform [JEDEC JS709B]				
Halogen Free	Conform [IEC 61249-2-21]				
Component Qualification	AEC-Q200 Grade 1				

General Information:

Ambient Temperature (referring to I _R)	-40 up to +85 °C			
Operating Temperature	-40 up to +125 °C			
Storage Conditions (in original packaging)	< 40 °C;< 75 % RH			
Moisture Sensitivity Level (MSL)	ISL) 1			
Test conditions of Electrical Properties: +20 °C, 33 % RH if not specified differently				
Test conditions of Performance Rated Current: refer to IEC 62024-2, Class D (PCB Copper Width: 40 mm; PCB Copper Thickness: 1000 µm)				
remperature rise is nighty dependent on many factors including PCB land pattern, trace size, and proximity to other components. Therefore, temperature rise should be verified in application conditions.				

CONCLUSION IEC STANDARD

- By using the IEC 62024-2:2020 we perform the measurement with highest possible transparency.
- Series can be compared on a defined level
- Better appraisal for end application by knowing the used PCB layout
- High trust for the value in the datasheet

Simulation Tool for specific PCB Design



Simulation Tool for specific PCB Design

·	Thickness
Temperature	
Ambient Temperature 20 °C O CALCULAT	Component Temperature 60 °C
Length (L) 20 mm Copper Thickness (H) 105 µm	Width (W) 40 mm
CALCULA	TE CURRENT



What else is missing?

- Power Inductors are mainly used in DC DC Converter.
- In a DC DC Converter the inductor needs to handle 2 currents.
 - DC losses
 - AC losses
- To have most usable result we suggest to use Redexpert which is calculation the total losses of the application



Simulation of AC Losses

z 📫 🙂 EXPERT Power Inductors ≡ menu Buck Converter Filters: Type = Single, Single HV I_{sat} ≥ 2.40 A I_R ≥ 2.01 A V_p ≥ 12.0 V ΔT_{TOT, L} ≤ 80.0 K 100 / 216 items 🔹 5.50 μH ≤ L@2.00 A ≤ 10.2 μH PARAMETERS Order Code Series Automotive 🍸 Spec Type 🍸 L₀ 🍸 L@2.00 A Size 6.03 µH 2.15 A 74438336068 WE-MAPI 202 6.80 µH 168 mΩ 3.65 A 22.0 MHz 3.00 mm \sim 3020 Single 40 % ±⊥ 74438357068 WE-MAPI 4030 6.80 µH 6.49 µH 69.4 mΩ 3.75 A 7.20 A 19.5 MHz 4.10 mm Single _ **▲**1 4.10 mm 4.1 ホ 500 kHz 74438357082 WE-MAPI 4030 1007 Single 8.20 µH 7.79 µH 81.0 mΩ 3.45 A 6.80 A 17.0 MHz ネ 74438357100 10.0 µH 9.43 µH 101 mΩ 3.05 A 5.95 A 15.0 MHz 4.10 mm WE-MAPI 4030 4.1 Sinal 0-8.20 µH 74438367082 WE-MAPI 5030 7.82 µH 50.0 mΩ 4.85 A 6.60 A 13.0 MHz 5.40 mm 5.4 Single Topology 7440650068 6.80 µH 6.57 µH 25.0 mΩ 4.20 A 3.60 A 30.0 MHz 10.0 mm WE-TPC 1028 600 Singl Sync 7.67 µH 3.80 A 10.0 mm 10 7440650082 WE-TPC 1028 100 Singl 8.20 µH 28.5 mΩ 2.80 A 28.0 MHz Non Sync 0744065100 WE-TPC 1028 10.0 µH 9.29 µH 40.0 mΩ 3.00 A 2.50 A 25.0 MHz 10.0 mm 10 1007 Single Input ☆ 7440660062 WE-TPC 1038 x Single 6.20 µH 6.09 µH 20.0 mΩ 5.00 A 4.50 A 25.0 MHz 10.0 mm 10 V_{inumax} 12 V V_{in,min} 10 V WE-TPC 1038 10.0 µH 9.70 µH 27.0 mΩ 3.90 A 4.00 A 20.0 MHz 10.0 mm 744066100 Single × Output > V_{out} 5V Iout 2A Click and type or drop an Order Code here Switch ■ MORE f_{sw} 500 kHz Show Panel: Lvs. I(T) Kvs. I(T) Inductor e Rise / DC C ΔI_L 40 % Show Suitable T = 20°C T = 20°C Diode A 00.5 V_f 0.7 V 6.5 uł 50 H **ODETAILS** 6 µH 5.5 µ 40 5 µ 30 K 2 4.5 uH 4 uH 20 3.5 µH 3 µH 500 mA 2.5 A 500 mA 1.A 1.5 A 2 A 2.5 A ЗA 3.5 A 4 A 4.5 A 5 A 1A 1.5 A 2 A ЗA 0 A 0 0 A Current Current



Simulation of AC Losses

< Buck Con	verter
PARAME	TERS
10.0 V 12.0 V 0.00V	40 % 2.00 A
Тороlоду	
Sync Non Sync	
Input	
V _{in,min} 10 V	V _{in,max} 12 V
Output	
V _{out} 5 V	I _{out} 2 A
Switch	
f _{sw} 500 kHz	
Inductor	
ΔI _L 40 %	Show Suitable v
Diode	
V _f 0.7 V	
	() DETAILS



CONCLUSION DEFINITION OF PERFROMANCE RATED CURRENT

- By using IEC Standard we have a method where values can be compared very easily
- By offering new PCB Layout tool we can offer custom specific DC heating simulation tool
- By offering Redexpert DC DC loss, we can offer a tool where AC loss can be calculated very convenient
- Self heating can be specified and simulated in all kind of complexity.
 - From comparing datasheet values up to expected self heating in end application

THANK YOU!

